**Datasheet** 

## SATADOM-SL 3ME3 V2 series

- Built-in Pin 8 power supply
- Best boot drive solution for server and embedded system
- SATA 6Gb/s interface
- High IOPS to reduce boot up timing
- DRAM-less, 100% data integrity
- Innovative Firmware Algorithm
- Anti-vibration mechanical design
- Built in iData Guard



## Introduction

Innodisk Serial ATA Disk on Module (SATADOM) supports SATA III standard (6.0Gb/s) interface with excellent performance, and SATADOM-SL 3ME V2 is designed as the smallest form factor size that could enhance compatibility with various design applications.

The innovative Pin8 uses the SATA connector itself as a power supply to drive the device without external cables. It could be connected directly to the SATA on-board socket on customers' system without additional power cable. Besides, the booting time for operation and the power consumption is less than hard disk drive (HDD), and can work under harsh environment compile with ATA protocol, no additional drives are required, and the SSD can be configured as a boot device or data storage device.



# **SATADOM-SL** 3ME3 V2 series

## Contact us for more information about the SATADOM-SL 3ME3 V2.

Innodisk is a service-driven provider of industrial embedded flash storage products and technologies, with a focus on the cloud computing, industrial/embedded, and aerospace and defense industries.

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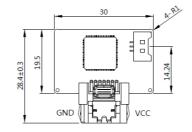
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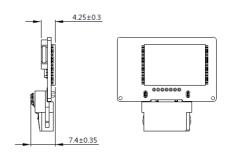
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TOLERANCE: ±0.20 mm

General Tolerance: ±0.2mm

## **Specifications**

**Diagram** 

Interface	SATA III			
Flash Type	MLC			
Capacity	8GB~128GB			
Max. Channels	2			
Sequential R/W (MB/sec, max.)	200 / 80			
Max. Power Consumption	1.8W (5V x 370mA )			
Thermal Sensor	WT only			
External DRAM buffer	-			
H/W Write Protect	-			
ATA Security	$\checkmark$			
S.M.A.R.T.	V			
Dimension (WxLxH)	30 X 28.4 X 7.4 mm			
Environment	Vibration: 20G @7~2000Hz Shock: 1500G @ 0.5ms Storage Temperature: -55°C ~ +95°C MTBF: 3 million hours			

## **Ordering Information**

Operation Temp.	8GB	16GB	32GB	64GB	128GB
Standard Grade (0°C ~ +70°C)	DESSL- 08GD09*C1SCA	DESSL- 16GD09*C1SCA	DESSL- 32GD09*C1SCA	DESSL- 64GD09*CADCA	DESSL- A28D09*CADCA
	DESSL- 08GD09*C1SCB	DESSL- 16GD09*C1SCB	DESSL- 32GD09*C1SCB	DESSL- 64GD09*CADCB	DESSL- A28D09*CADCB
Industrial Grade (-40°C ~ +85°C)	DESSL- 08GD09*W1SCA	DESSL- 16GD09*W1SCA	DESSL- 32GD09*W1SCA	DESSL- 64GD09*WADCA	DESSL- A28D09*WADCA
	DESSL- 08GD09*W1SCB	DESSL- 16GD09*W1SCB	DESSL- 32GD09*W1SCB	DESSL- 64GD09*WADCB	DESSL- A28D09*WADCB

\* S: Toshiba A19nm MLC/ B: Toshiba 15nm MLC PN end with A: Pin8+ power cable / B: Pin8+ Pin 7

